



Surface Mount General Purpose Silicon Rectifiers

FEATURES:

- For surface mounted applications
- · Low profile package
- Glass Passivated Chip Junction
- · Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives

Circuit Diagram & Pin Configuration:





SMA/DO-214AC

Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

| Parameter | Symbols | S1A | S1B | S1D | S1G | S1J | S1K | S1M | Units |
|--|--------------------|------------|-----|-----|-----|-----|-----|------|-------|
| Maximum Repetitive Peak Reverse Voltage | V_{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V_{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | V _{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current | I _{F(AV)} | 1 | | | | | | Α | |
| Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load | I _{FSM} | 30 | | | | | | А | |
| Maximum Instantaneous Forward Voltage at 1 A | V _F | 1.1 | | | | | | V | |
| Maximum DC Reverse Current $T_a = 25 ^{\circ}\text{C}$ at Rated DC Blocking Voltage $T_a = 125 ^{\circ}\text{C}$ | I _R | 5 50 | | | | | | μА | |
| Typical Junction Capacitance (1) | C _j | 15 | | | | | pF | | |
| Typical Thermal Resistance (2) | $R_{\theta JA}$ | 75 | | | | | | °C/W | |
| Operating and Storage Temperature Range | T_{j},T_{stg} | -55 ~ +150 | | | | | °C | | |

⁽¹⁾ Measured at 1 MHz and applied reverse voltage of 4 V D.C

Marking

| Type number | Marking code | | | | |
|-------------|--------------|--|--|--|--|
| S1A | S1A | | | | |
| S1B | S1B | | | | |
| S1D | S1D | | | | |
| S1G | S1G | | | | |
| S1J | S1J | | | | |
| S1K | S1K | | | | |
| S1M | S1M | | | | |

⁽ 2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.





Fig.1 Forward Current Derating Curve

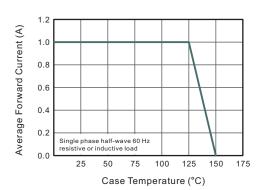


Fig.2 Typical Reverse Characteristics

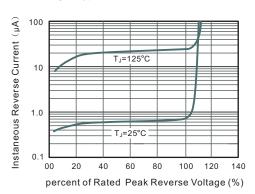


Fig.3 Typical Forward Characteristic

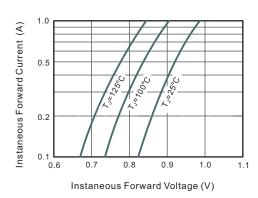


Fig.4 Typical Junction Capacitance

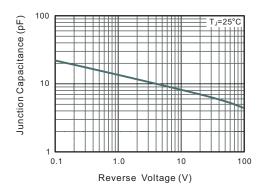
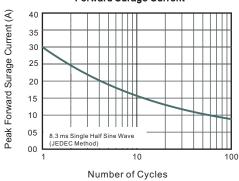


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current



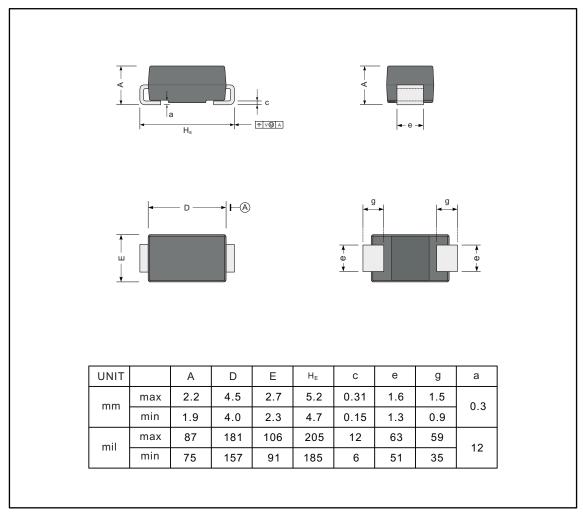




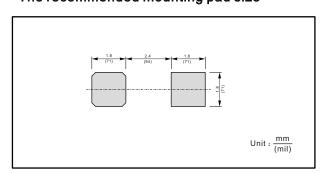
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMA/DO-214AC



The recommended mounting pad size





S1A THRU S1M

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